# uClamp4014P 40V µClamp® 4-Line ESD Protection

## PROTECTION PRODUCTS - MicroClamp®

### Description

 $\mu Clamp^{\circledast}$  TVS diodes are designed to protect sensitive electronics from damage or latch-up due to ESD. They feature large cross-sectional area junctions for conducting high transient currents. This device offers desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

The  $\mu$ Clamp®4014P is in a 10-pin SGP2510P8 package measuring 2.5 x 1.0mm with a nominal height of only 0.60mm. Leads are finished with lead-free NiPdAu. Each device will protect four lines operating at +/- 40 volts. This device gives the designer flexibility to replace multiple single line devices in space constrained applications. The flow through package design simplifies PCB layout. uClamp4014P may be used to meet the ESD immunity requirements of IEC 61000-4-2. The combination of high ESD surge capability and innovative package design makes them ideal for use in applications such as LCD Televisions, monitors, and industrial equipment.

#### **Features**

- ◆ High ESD withstand Voltage: +/-18kV (Contact) per IEC 61000-4-2
- Protects up to four VBus lines
- ◆ Flow-Through Package
- ◆ Low reverse current: <10nA typical (VR=40V)</p>
- ◆ Working voltage: +/- 40V
- ◆ Dynamic resistance: 2 Ohms (Typ)
- Solid-state silicon-avalanche technology

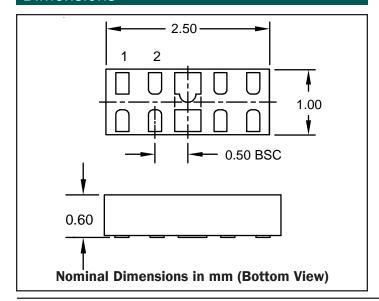
#### **Mechanical Characteristics**

- ◆ SGP2510P8 10-pin package (2.5 x 1.0 x 0.60mm)
- Lead Pitch: 0.5mm
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant
- Molding compound flammability rating: UL 94V-0
- Marking: Marking code + date code
- Packaging: Tape and Reel

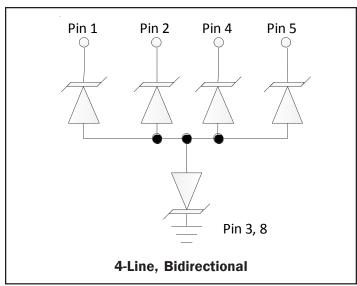
### **Applications**

- Chip-On-Glass (COG) Panels
- VBus Protection
- LCD Televisions
- Set Top Box
- ◆ Industrial Equipment

#### **Dimensions**



## Circuit Diagram





Absolute Maximum	Rating
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Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P <sub>pk</sub>	225	Watts
Maximum Peak Pulse Current (tp = 8/20μs)	I <sub>pp</sub>	3	Amps
ESD per IEC 61000-4-2 (Air) <sup>1</sup> ESD per IEC 61000-4-2 (Contact) <sup>1</sup>	V <sub>ESD</sub>	+/- 20 +/- 18	kV
Operating Temperature	T,	-55 to +125	°C
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V <sub>RWM</sub>	Pins 1, 2, 4, and 5 to Pins 3 & 8			40	V
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>t</sub> = 1mA Pins 1, 2, 4, or 5 to Pins 3 & 8	42	47	52	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 40V, T=25°C Pins 1, 2, 4, or 5 to Pins 3 & 8		<0.005	0.250	μА
Clamping Voltage	V <sub>c</sub>	I <sub>PP</sub> = 3A, tp = 8/20μs Pins 1, 2, 4, or 5 to Pins 3 & 8			75	V
ESD Clamping Voltage <sup>2</sup>	V <sub>c</sub>	I <sub>PP</sub> = 4A, tlp = 0.2/100ns Pins 1, 2, 4, or 5 to Pins 3 & 8		54		V
ESD Clamping Voltage <sup>2</sup>	V <sub>c</sub>	I <sub>PP</sub> = 16A, tlp = 0.2/100ns Pins 1, 2, 4, or 5 to Pins 3 & 8		78		V
Dynamic Resistance <sup>2, 3</sup>	R <sub>Dyn</sub>	tp = 100ns		2		Ohms
Junction Capacitance	C <sub>j</sub>	V <sub>R</sub> = 40V, f = 1MHz Pins 1, 2, 4, or 5 to Pins 3 & 8		5	10	pF

#### Notes

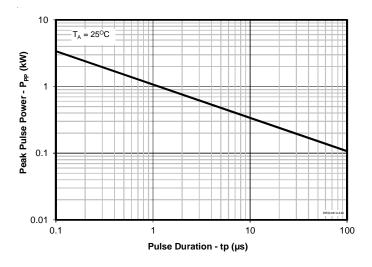
<sup>1)</sup> ESD gun return path connected to ESD ground plane.

<sup>2)</sup>Transmission Line Pulse Test (TLP) Settings:  $t_p = 100$ ns,  $t_r = 0.2$ ns,  $I_{TLP}$  and  $V_{TLP}$  averaging window:  $t_1 = 70$ ns to  $t_2 = 90$ ns. 3) Dynamic resistance calculated from  $I_{pp} = 4A$  to  $I_{pp} = 16A$ 

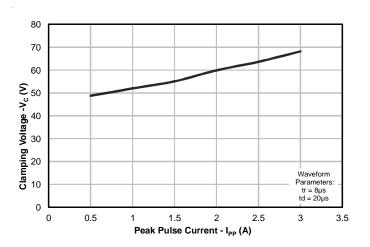


## Typical Characteristics

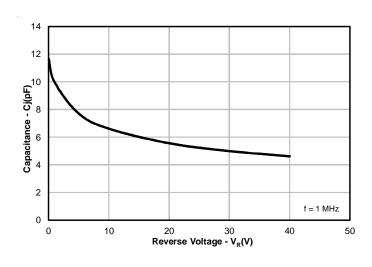
#### Non-Repetitive Peak Pulse Power vs. Pulse Time



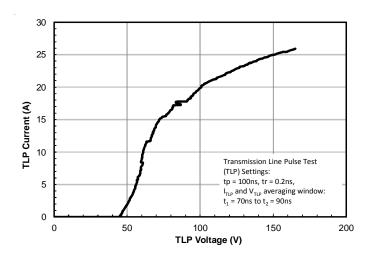
#### Clamping Voltage vs. Peak Pulse Current (tp=8/20us)



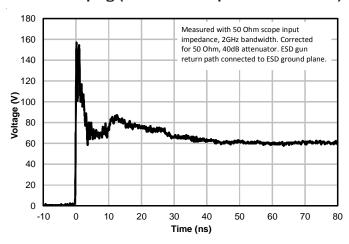
#### Junction Capacitance vs. Reverse Voltage



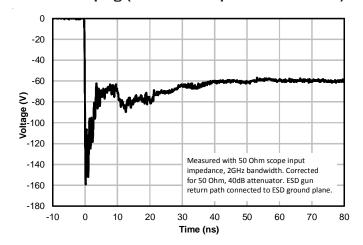
#### **TLP Characteristic**



#### ESD Clamping (+8kV Contact per IEC 61000-4-2)

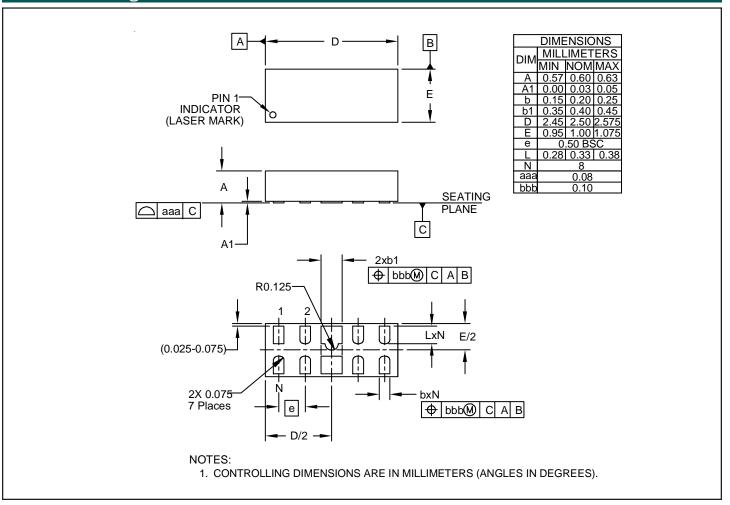


#### ESD Clamping (-8kV Contact per IEC 61000-4-2)

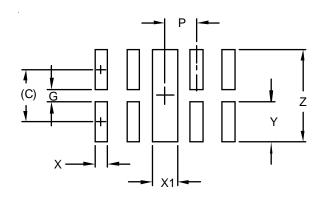




## Outline Drawing - SGP2510P8



## Land Pattern - SGP2510P8



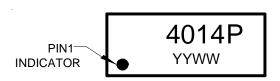
DIMENSIONS			
DIM	MILLIMETERS		
С	(0.825)		
G	0.20		
Р	0.50		
Χ	0.20		
X1	0.40		
Υ	0.625		
Ζ	1.45		

#### NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.



## Marking Code



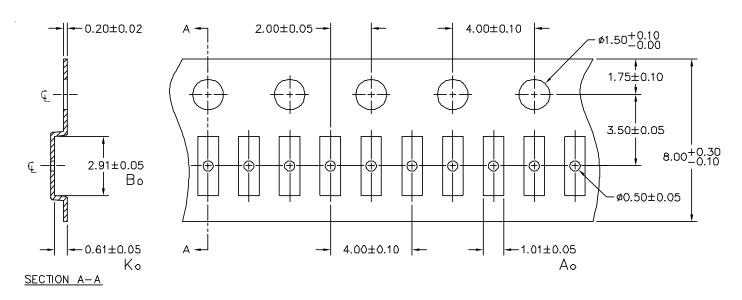
# Ordering Information

Part Number	Qty per Reel	Reel Size	
uClamp4014P.TNT	10,000	7 Inch	

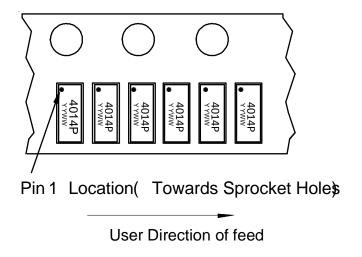
Notes:

MicroClamp, uClamp and  $\mu Clamp$  are trademarks of Semtech Corporation

## Carrier Tape Specification



NOTES: 1.) ALL DIMENSIONS IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.



**Device Orientation in Tape** 



# Contact Information

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